

# APPLICATION GUIDE FOR INDIVIDUAL RESEARCH GRANTS & YOUNG INDIVIDUAL RESEARCH GRANTS (MANUFACTURING, TRADE AND CONNECTIVITY DOMAIN)

## OVERVIEW

1. Under the Research, Innovation and Enterprise (RIE) 2025, the Manufacturing, Trade and Connectivity (MTC) domain aims to strengthen Singapore's positioning as a manufacturing hub and a Global-Asia node for technology, innovation, and enterprise by further enhancing our manufacturing capabilities and cross-domain technologies that will seed growth in adjacent sectors. Details on the MTC domain's strategies and goals can be found at <http://www.nrf.gov.sg/rie2025-plan>.

2. The MTC **Individual Research Grants (IRG)** aims to support novel and fresh R&D investigator-led ideas. Proposals are solicited through a ground-up mechanism across the research ecosystem. The IRG allows for submissions from either single Principal Investigators (PIs), or small PI teams<sup>1</sup>. Meanwhile, the **Young Individual Research Grants (YIRG)** is a sub-category of grants aims at grooming young researchers<sup>2</sup> in conducting independent research. A\*STAR has been appointed as the Implementing Agency for the MTC IRG and YIRG.

## LAUNCH OF GRANT CALL

3. The 2023 MTC IRG and YIRG grant calls will open on **9 May 2023** and close on **20 June 2023, 11.59 pm (Singapore Standard Time)**. Results are expected to be announced by Jan 2024

4. The grant calls are open to all locally funded public sector research performers including the Institutes of Higher Learning (including universities and polytechnics), A\*STAR Research Institutes, and non-defense-related public sector agencies (e.g., Ministries, Statutory Boards). Industry and non-local research performers can participate as collaborators, but will not be eligible for any funding.

5. Proposals can focus on any research areas that fall under the MTC domain. Within the domain, twelve key industry sectors under three major groups have been identified for RIE2025 (refer to **Annex A**). These are:

- Manufacturing & Trade
  - Aerospace
  - Energy and Chemicals
  - Electronics
  - Precision Engineering
  - Marine and Offshore
  - Food Manufacturing
  - Biomedical Manufacturing
  - Logistics
  
- Connectivity
  - Aviation
  - Sea Transport
  - Satellites

6. Selection of successful proposals will be based on, but not limited to, the following evaluation criteria:

- a) The track record of the PI
- b) The novelty, intellectual and innovative merit of the proposal
- c) The competitive and comparative advantage of the proposal
- d) Potential scientific/technical impact based on the proposed deliverables

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<sup>1</sup> PI teams may be formed between different institutions for IRG.

<sup>2</sup> "Young Researchers" are defined as researchers with up to 7 years of post-doctoral experience.

e) The feasibility of implementing the proposed methodology and execution of the chosen approach

7. Notwithstanding the above criteria, the evaluation panel reserves the right to make a final decision based on other strategic considerations.

8. Each applicant is only allowed to submit one application as a Principal Investigator (PI) for either the IRG or the YIRG. Only one Lead PI is allowed per application. Applicants should not have any outstanding reports for all national grants currently or previously held.

## ELIGIBILITY CRITERIA

9. Applicants are generally required to fulfil the following criteria **at the point of application**:

	IRG	YIRG
<b>Max. funding quantum<sup>3</sup></b>	Typically up to \$1.2M per project (inclusive of 30% indirect costs) over 3 years. Applicants are advised to budget their projects prudently.	Typically up to \$325k per project (inclusive of 30% indirect costs) over 3 years. Applicants are advised to budget their projects prudently.
<b>Age</b>	Any age	Any age
<b>Academic qualification</b>	PhD	PhD (not more than 7 years post-PhD)
<b>Employment</b>	Holds a primary appointment of at least 75% in a local publicly funded institution and salaried by the institution.	
<b>Past funding received</b>	-	PI of an on-going MTC/AME IRG or MTC/AME YIRG project will not be eligible.
<b>Mentorship support</b>	Not required	Applicants are required to work with a mentor for guidance in their research. Applicants' current supervisor can be the mentor for the proposal but not a Team PI, Co-I or Collaborator. Applicants must indicate how the proposed area of work would be distinct from their current supervisors' existing research.

10. In addition to the above criteria, applicants should not have any outstanding report from previous A\*STAR grants, NMRC grants, and other national grants.

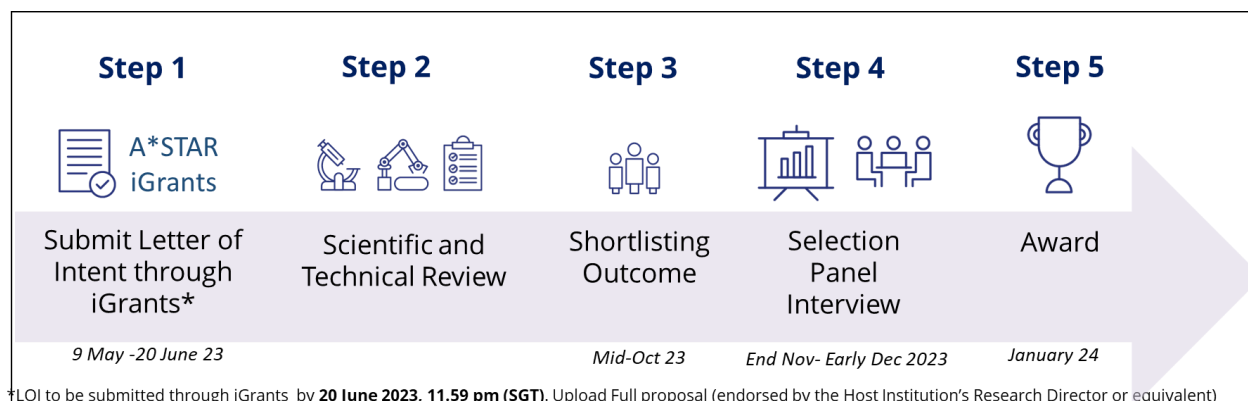
## REVIEW PROCESS

11. All proposals will be subject to scientific and technical review. Shortlisted applicants may be invited to present their proposals to a panel of reviewers. The entire review process is expected to take up to 6 months from the grant call closing date. As the decisions are final, we are unable to consider any appeals.

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<sup>3</sup> The funding supports eligible costs related to manpower, equipment, consumables, and travel, subject to A\*STAR's terms and conditions. It also supports indirect costs (IRC) capped at 30% of direct costs.

## GRANT CALL TIMELINE



### 12. Indicative Timeline:

Stage 1: Proposal Submission	
Opening of grant call on iGrants	9 May 2023
Deadline for submission on iGrants	20 June 2023
Shortlisting Outcome	Mid-October 2023
Stage 2: Presentation (For shortlisted applicants only)	
Deadline for submission of presentation deck	Mid-October 2023
Presentation to Review Panel	End November- Early December 2023
Grant Award	January 2024

## APPLICATION PROCESS

13. All applications should be submitted through the A\*STAR's Grant Application and Grant Evaluation system (iGrants) (<https://igrants-app.a-star.edu.sg/>) by **20 June 2023, 11.59 pm (Singapore Standard Time)**. Late and incomplete submissions will not be accepted.

14. The following completed document (using the requisite template) should be uploaded to the relevant sections in iGrants:

- a) Full proposal

15. Each proposal must be endorsed by the Host Institution's Research Director or equivalent prior to submission. This is to ensure that there is organisational support for the PI to participate in the grant call.

16. For any clarification, please contact the Implementing Agency, A\*STAR, at [IRG\\_MTC@hq.a-star.edu.sg](mailto:IRG_MTC@hq.a-star.edu.sg).

### Manufacturing, Trade & Connectivity (MTC)

#### Domain Focus Areas for MTC IAF-PP, Programmatic and IRG

The following document gives a brief outline of the focus areas for each of the MTC domain, for the sole purpose of preparing grant applications for the MTC IAF-PP, Programmatic and IRG Funding Initiatives.

Grant applications should address the following:

- The specific problem in the domain focus area/key capability/application that the proposal is attempting to address
- A clear description of the proposal's approach, and how it is differentiated from other international efforts
- IP development and IP value capture plans
- (IAF-PP) Extent of local value capture in Singapore, and potential for new/differentiated products or services in or via Singapore
- (Programmatic/IRG) How the proposal aims to build scientific excellence and capabilities

Grant applications in areas not listed below are welcome for submission, but such applications must clearly articulate how they aim to address the challenges and needs of the MTC domain, and the pathway towards commercialization in Singapore (<https://www.nrf.gov.sg/rie2025-plan/manufacturing-trade-and-connectivity>)

## Precision Engineering (Additive Manufacturing)

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Aerospace/Space	<ul style="list-style-type: none"> <li>Fast efficient computational/digital models for quick robust evaluation of parts and processes</li> <li>Composite Materials (Metal, Polymer &amp; Ceramics)</li> <li>Lightweighting &amp; Generative Design</li> <li>End-to-End Hybrid AM process &amp; system integration</li> <li>Integrated end-to-end digital workflow</li> <li>Post Processing (Hot Isostatic Pressing, machining)</li> </ul>	<ul style="list-style-type: none"> <li>Materials and design for lightweighting &amp; high temperature (metal, polymer, ceramics &amp; composites).</li> <li>New AM material for the aerospace sector e.g. specialised metal alloys, specialised ceramic-metal composites, high-temp high-performance polymer composites, Continuous Fibre Reinforced Polymers (CFRP).</li> </ul>
		<ul style="list-style-type: none"> <li>Development of composite materials and hybrid multi material printing capabilities. eg: 4D printing for deployable structures and smart components with increased functionality &amp; sensorization, structural battery power storage systems, multi material printing.</li> </ul>
		<ul style="list-style-type: none"> <li>Development and optimization of print repeatability.</li> <li>Development of standards for in-process monitoring for various AM technologies</li> <li>Powder recyclability for AM sustainability</li> </ul>
		<ul style="list-style-type: none"> <li>HIP capability, advanced robotic machining, internal surface finish technologies, integrated process development</li> <li>Automation of post-processing with AM</li> <li>In-process monitoring systems</li> <li>Material-process-property correlations and machine variability</li> <li>Optimization of post processing for part quality (HIP, heat treatment, surface finish, etc.)</li> </ul>
M&O, Maritime and Land Transport	<ul style="list-style-type: none"> <li>Digital Models for rapid part qualification</li> <li>Metal alloys &amp; metal composites</li> <li>Polymer &amp; polymer composites</li> <li>Wire-based &amp; Powder-based large format printing (metal &amp; polymer)</li> <li>Hybrid Manufacturing</li> <li>End-to-end Hybrid AM process &amp; system integration</li> <li>Integrated end-to-end digital workflow</li> </ul>	<ul style="list-style-type: none"> <li>Integration of topology optimization and process development (Building of additional functions based on industry needs, development of digital twin and models)</li> </ul>
		<ul style="list-style-type: none"> <li>Development of novel advanced materials, such as high-entropy metals, metal and ceramics, composite matrices, Continuous Fibre Reinforced Polymers (CFRP)</li> <li>Metallic Additive Materials for AM processes and corrosion resistant steel.</li> <li>Development and industry acceptance of sustainable AM materials</li> </ul>
		<ul style="list-style-type: none"> <li>Building and scaling of large-scale Directed-Energy Deposition (DED) and hybrid platforms with integrated smart systems</li> <li>Smart/Reconfigurable Factory with AM, including integrated part inspection methods, eg automatic inspection, quality assurance, non-destructive testing, etc.</li> <li>Development of part build strategies with large format 3D printing and DED based technologies for new builds and repair</li> </ul>
		<ul style="list-style-type: none"> <li>Development of novel post-processing methods such as internal channel support removal, etc.</li> <li>Development of HIP processes</li> <li>Hybrid Processing combining AM with joining, casting, and CNC/robotic machining etc.</li> <li>In-process monitoring system</li> <li>Improvements to process repeatability and parts reliability</li> <li>Development and integration of blockchain into workflows for traceability and IP protection</li> </ul>
Precision Engineering & Complex Machinery	<ul style="list-style-type: none"> <li>Integrated CAD/CAM workflow &amp; end-to-end digital workflow</li> <li>End-to-end Hybrid AM process &amp; system integration</li> <li>In-process close-loop feedback</li> <li>Integrated End-to-end digital workflow</li> <li>Post Processing (advanced machining)</li> </ul>	<ul style="list-style-type: none"> <li>Advanced material and multi material printing technology (metal, polymer, ceramics, composites)</li> </ul>
		<ul style="list-style-type: none"> <li>Optics printing systems - improved optics fabrication and resolution especially in micro-optics</li> <li>Development of smart machines (inclusive of capability to print micro-size features with high consistency and high throughput)</li> <li>Integration of software and hardware to enable quality control including process stability.</li> <li>Efficient fine feature printing (point-based, line-based or layer-based technology)</li> </ul>
		<ul style="list-style-type: none"> <li>In-process monitoring system and closed-loop feedback, for process stability and consistent quality.</li> <li>Component to module fabrication: Design for function.</li> <li>Resolution coupled with fast speed and large area output (micro features, hybrid processing)</li> </ul>
		<ul style="list-style-type: none"> <li>Data analytics for AM: Requirement for smart AM machines</li> <li>Component to module fabrication: post-processing</li> <li>Part traceability, certification, and standardisation</li> </ul>

MedTech, Healthcare, Drugs and Food	<ul style="list-style-type: none"> <li>• Tissue/Organ Engineering</li> <li>• Implants</li> <li>• Pharmaceuticals/Supplements</li> <li>• Food Printing for the Aged</li> <li>• Cellular Agriculture</li> <li>• Medical Devices</li> <li>• Point of Care Healthcare</li> <li>• End-to-end Hybrid AM process &amp; system integration</li> <li>• 4D printing (smart materials &amp; smart devices)</li> </ul>	<ul style="list-style-type: none"> <li>• Customised surgical guides &amp; models to suit specific procedures</li> <li>• Tissue Engineering (scaffolds) using AM, regenerative medicine, Tissue Implants and Tissue Model for material and product testing (Short Term), wound restoration (regeneration)</li> <li>• Customised implants &amp; prosthetics, new testing methodologies for customised implants and prosthetics</li> <li>• Personalized medicine, small volume manufacturing for new drug testing, nutrition adjustment for seniors, printing optimization to ensure better organoleptic profile of novel foods/meats</li> <li>• Cellular agriculture and production of agricultural products</li> <li>• Smart implants and other medical devices; Implants and other medical devices with embedded advanced electronics, such as stents.</li> </ul>
		<ul style="list-style-type: none"> <li>• Safe, more biocompatible, biomimetic and printable materials/material formulations.</li> <li>• New materials with enhanced biocompatibility meeting product-specific requirements.</li> </ul>
		<ul style="list-style-type: none"> <li>• Printer compatibility with material, improvements to printing speeds, improving functions of products, finishing and biocompatibility of products to ensure safety and efficacy.</li> </ul>
		<ul style="list-style-type: none"> <li>• Data processing &amp; standards: Data quality and reliability to ensure reliable product outputs</li> <li>• Comprehensive downstream eco-system development including regulatory, prototyping, manufacturing for translation and implementation.</li> </ul>
Built Environment	<ul style="list-style-type: none"> <li>• Multi Materials</li> <li>• Autonomous Gantry 3D printing</li> <li>• Structural and Non Structural</li> <li>• Design</li> <li>• Carbon-Neutral (Negative) Concrete</li> <li>• 4D Materials Façade</li> <li>• Energy Net-Zero Building</li> </ul>	<ul style="list-style-type: none"> <li>• New construction materials/ composite materials and advanced materials</li> <li>• Integration of metal and concrete, printing of rebar and concrete simultaneously for better bonding properties</li> <li>• Integration of metal – carbon fiber and graphene</li> <li>• Conductive materials – integration of services / optical fibers / solar cells</li> <li>• Higher load bearing and structural applications and capabilities</li> <li>• Development of carbon capture concrete (carbon negative materials in construction)</li> </ul>
		<ul style="list-style-type: none"> <li>• Large-scale, portable, reconfigurable, customisable platforms, autonomous/ robots</li> <li>• New printer systems and printing methodology for multi-materials</li> <li>• Integration of sensors for construction 3D printing</li> <li>• Construction of smart structures, bridges, habitats, ancillary buildings for data and user analysis</li> <li>• 4D Printing</li> <li>• Intelligent building, building components that respond to external stimuli for thermal efficiency</li> <li>• Development and optimisation of processes for concrete 3D printing with re-bars / in-fills</li> </ul>
		<ul style="list-style-type: none"> <li>• New printing methodologies and processes for large parts (non-structural and structural)</li> </ul>
		<ul style="list-style-type: none"> <li>• Development of standards to be adopted by BCA, HDB and developers as part of building codes.</li> <li>• Development of accredited procedures and processes for building components, ie walls, ceilings, floors</li> <li>• Develop testing certification programme with TUV-SUD, ASTM and BCA</li> <li>• Researchers/ skilled manpower trained in robotics and automation of building processes</li> <li>• Setting up a Joint Research Lab with BCA Academy and Industry Partners to train and integrating Industry 4.0 for Construction 3DP</li> </ul>
CleanTech	<ul style="list-style-type: none"> <li>• Large Format Printing</li> <li>• Solid-state printing</li> <li>• Powder-bed &amp; sintered based AM</li> <li>• Electric Motors</li> <li>• Renewable Energy Infrastructure</li> <li>• Generative Design</li> <li>• Composite Materials</li> <li>• Recycled Feedstock (Metal, Polymers)</li> <li>• Sustainability in design, process and delivery</li> <li>• End-to-end Hybrid AM process &amp; system integration</li> </ul>	<ul style="list-style-type: none"> <li>• Design and simulation of 3D printed renewable structures</li> <li>• Advanced AM Materials &amp; new printing technologies for CleanTech applications and products such as battery, fuel cells, water membranes, thermal management products, electrochemical energy storage</li> </ul>
		<ul style="list-style-type: none"> <li>• Large format metal and polymer printing technology for products such as wind turbines nacelles</li> <li>• Large scale 3D printing of renewable energy structures</li> </ul>
		<ul style="list-style-type: none"> <li>• Capability for parts repair, replacement and remanufacturing technology with AM</li> </ul>
		<ul style="list-style-type: none"> <li>• Standards for new AM materials and applications in the renewable space</li> </ul>

## Precision Engineering (Laser & Optics)

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Flat Optics/Metalenses	<ul style="list-style-type: none"> <li>• Modeling and simulation</li> <li>• Design</li> <li>• New material development</li> <li>• Fabrication techniques</li> </ul>	<ul style="list-style-type: none"> <li>• Broadband / achromatic and efficient flat optics (imaging, lenses, fibre integration, structured light)</li> </ul>
		<ul style="list-style-type: none"> <li>• Flat optics system integration (imaging, 3D sensing, HUD/HMD)</li> </ul>
		<ul style="list-style-type: none"> <li>• Deep-UV &amp; resilient flat optics</li> <li>• Soft X-ray/EUV flat optics</li> </ul>
		<ul style="list-style-type: none"> <li>• Engineered micro-optics</li> </ul>
Fibre Lasers	<ul style="list-style-type: none"> <li>• Laser sources</li> <li>• Laser system and components</li> </ul>	<ul style="list-style-type: none"> <li>• Wavelength-tunable DUV generation</li> <li>• Ultrashort (&lt;10 fs) pulse generation</li> </ul>
		<ul style="list-style-type: none"> <li>• High power beam combiners at near IR and eye safe wavelengths (&gt;1 kW)</li> <li>• Hollow core fibre based combiners and splitters</li> </ul>
		<ul style="list-style-type: none"> <li>• Beam delivery hollow core fibre near IR, 1 kW and ultrafast lasers</li> <li>• Beam delivery hollow core fibre (VUV)</li> <li>• Hollow core fibre for &gt; 5 mm applications (delivery, supercontinuum source)</li> </ul>
		<ul style="list-style-type: none"> <li>• Deep learning with small number of samples (HMLV)</li> <li>• High speed processing</li> <li>• Low contrast features detection &amp; identification</li> </ul>
Image Processing and Metrology	<ul style="list-style-type: none"> <li>• Intelligence for automated inspection</li> <li>• 3D inline inspection</li> </ul>	<ul style="list-style-type: none"> <li>• Freeform / complex geometric surface inspection</li> <li>• High resolution X-ray inspection (&lt; sub <math>\mu\text{m}</math>)</li> </ul>
		<ul style="list-style-type: none"> <li>• Coatings for DUV-UV-VIS-IR optics</li> <li>• PVD process for applications with high thermal stability up to 400 degrees Celsius</li> <li>• PVD-based hybrid coating for ultra high temperatures &amp; wear protection</li> <li>• Computational materials design &amp; multifunctional development for new coatings &amp; processes for harsh environments</li> </ul>
Functional Coatings for Optics	<ul style="list-style-type: none"> <li>• Coating materials</li> <li>• Coating processes</li> </ul>	<ul style="list-style-type: none"> <li>• Coatings for DUV-UV-VIS-IR optics</li> <li>• PVD process for applications with high thermal stability up to 400 degrees Celsius</li> <li>• PVD-based hybrid coating for ultra high temperatures &amp; wear protection</li> <li>• Computational materials design &amp; multifunctional development for new coatings &amp; processes for harsh environments</li> </ul>



## Aerospace

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Digitalisation and Automation	<ul style="list-style-type: none"> <li>• Data Analytics</li> <li>• Visual Analytics</li> <li>• Artificial Intelligence</li> <li>• Robotics/Cobots</li> <li>• IOT</li> <li>• 5G Applications</li> </ul>	<ul style="list-style-type: none"> <li>• Leveraging aircraft / equipment data to create new service offerings, e.g. aircraft health monitoring, resource optimisation</li> </ul>
		<ul style="list-style-type: none"> <li>• Automation of manufacturing / maintenance processes, e.g. high-mix low-volume applications</li> </ul>
		<ul style="list-style-type: none"> <li>• Improving shopfloor intelligence and decision-making for operations/processes in the hangars or workshops</li> </ul>
Advanced Materials	<ul style="list-style-type: none"> <li>• Polymer Composites</li> <li>• Ceramic Composites</li> <li>• Metal Alloys</li> <li>• Functional Coatings</li> <li>• NDI/NDT</li> </ul>	<ul style="list-style-type: none"> <li>• Development of advanced materials for new applications, e.g. in harsh environment, lightweighting of aircraft structures</li> </ul>
		<ul style="list-style-type: none"> <li>• Improving manufacturability to reduce production costs, and repairability</li> </ul>
		<ul style="list-style-type: none"> <li>• Enhanced inspection techniques for in-service aircraft / engine parts to improve accuracy, turn-around time etc.</li> </ul>
Modelling & Simulation	<ul style="list-style-type: none"> <li>• Digital Twin</li> <li>• Integrated Computational Materials Engineering</li> <li>• Model-based systems engineering</li> </ul>	<ul style="list-style-type: none"> <li>• Digital twins for manufacturing processes (e.g. AM, welding, cold spray) for parameter optimisation and to support the enhancement of materials and manufacturing processes.</li> </ul>
		<ul style="list-style-type: none"> <li>• Development of material models and integration of the models of various length scales in an Integrated Computational Materials Engineering (ICME) approach, to enhance understanding of associated processing methods and mechanical properties.</li> </ul>
		<ul style="list-style-type: none"> <li>• Model-based systems engineering (MBSE) to companies' product / system development process covering system requirements, design, analysis, verification and validation, from the conceptual design phase to development and later life cycle phases.</li> </ul>
Additive Manufacturing	<i>Refer to Precision Engineering (Additive Manufacturing) Aerospace/Space Focus Area.</i>	
Autonomy	<ul style="list-style-type: none"> <li>• Sensors</li> <li>• AI / Algorithms</li> </ul>	<ul style="list-style-type: none"> <li>• Sensors / software for new or improved autonomous performance of aircraft system</li> </ul>
		<ul style="list-style-type: none"> <li>• New aircraft concepts for urban air mobility applications</li> </ul>
		<ul style="list-style-type: none"> <li>• Unmanned Traffic Management (UTM), and UTM integration into manned airspace</li> </ul>
Sustainable Aviation	<ul style="list-style-type: none"> <li>• Electrification</li> <li>• Alternative Fuels</li> <li>• Alternative Shopfloor Processes</li> </ul>	<ul style="list-style-type: none"> <li>• Development of supporting materials, electronics and systems (e.g. battery management system) for use in More-Electric Aircraft and future electrical propulsion systems</li> </ul>
		<ul style="list-style-type: none"> <li>• Sustainable aviation fuels (SAF), alternative fuels (eg hydrogen) and their associated materials analysis and metrological needs, to support industry adoption.</li> </ul>
		<ul style="list-style-type: none"> <li>• Development of more sustainable or environmentally friendly alternatives to existing shopfloor processes, e.g. to reduce reliance on harmful chemicals or to reduce energy requirements.</li> </ul>

## Marine & Offshore

Focus Areas/Technology Verticals	Key Capabilities and Applications
Offshore Renewable Energy	<ul style="list-style-type: none"> <li>• Predictability of operating environment</li> <li>• Design, implementation &amp; operations of offshore renewable energy systems, including floating offshore wind</li> <li>• Coupled vessel + marine robotics for operations &amp; maintenance</li> </ul>
	<ul style="list-style-type: none"> <li>• Metocean platform, including for Southeast Asian seas</li> </ul>
	<ul style="list-style-type: none"> <li>• Intelligent asset management of offshore wind and ocean energy systems</li> </ul>
Marine Electrification and Clean Fuels Supply Chain Solutions	<ul style="list-style-type: none"> <li>• Predictability of operating environment</li> <li>• Vessel or platform for production, offloading, transport and storage</li> <li>• Vessel or platform powered by LNG and clean fuels</li> <li>• Risk assessment for clean fuels</li> </ul>
	<ul style="list-style-type: none"> <li>• Design concept of a smart FPSO and other platforms for LNG, novel energy or CO<sub>2</sub>, and ammonia/LH<sub>2</sub> or CO<sub>2</sub> carrier</li> <li>• Intelligent asset management</li> </ul>
	<ul style="list-style-type: none"> <li>• Design of a vessel with operating range &amp; endurance similar to that of fossil-fuel powered vessels via digitalisation and AI Tool for Ship Design, including hull, propeller and other key systems, electrification, and novel techniques e.g. wing-in-ground</li> </ul>
	<ul style="list-style-type: none"> <li>• Simulation of gas leakage + explosion, and assessment of impact on platforms, gas carriers or terminals to identify safety considerations to facilitate design, planning and operations. e.g rapid prediction of plume dispersion for safety monitoring + leak source identification</li> </ul>
Smart Ocean Systems	<ul style="list-style-type: none"> <li>• Cyber Physical systems with real-time predictability and control</li> <li>• Autonomous and remotely operated systems, and robotics, including coupled human-machine and vessel – underwater robotics / aerial vehicle operations</li> <li>• Biomimetic systems for underwater or surface vehicles</li> </ul>
	<ul style="list-style-type: none"> <li>• Smart systems for greater efficiency, reliability, safety and resilience, through enhanced decision support, intelligent asset management, and enabling life-extension (e.g. existing FPSOs)</li> </ul>
	<ul style="list-style-type: none"> <li>• Autonomous systems for maintenance of offshore wind farms and ocean energy systems: autonomous inspection, including to define and enhance operating envelopes of coupled systems with man-in-the-loop via remote control</li> </ul>
	<ul style="list-style-type: none"> <li>• Biomimetic swimming mechanisms to enhance operational endurance of ocean systems, targeted at underwater vehicles for applications on (i) inspection of subsea pipelines + telco/power networks, (ii) deep sea mining ops, and (iii) seabed surveys</li> </ul>
Nearshore Infrastructure addressing SG national priorities	<ul style="list-style-type: none"> <li>• Smart multi-purpose, multi-body, nearshore infrastructure for habitats and other socio-economic uses complementary with coastal defence networks</li> </ul>
	<ul style="list-style-type: none"> <li>• Design, implementation and operations of large-scale floating systems, involving dynamics of coupled bodies, including fatigue and stress analysis</li> </ul>
	<ul style="list-style-type: none"> <li>• Design, implementation and ops of deepwater cages + other novel concepts for sustainable aquaculture farms, inc. use of ocean energy</li> </ul>

## Logistics

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Digitalisation	<ul style="list-style-type: none"> <li>• Artificial Intelligence</li> <li>• Machine Learning</li> <li>• Low Code Platforms</li> <li>• Data Analytics</li> <li>• Digital Control Tower</li> <li>• Supply Chain Planning</li> </ul>	System-level AI for real-time advisory <ul style="list-style-type: none"> <li>• AI Toolkit for reduced failed deliveries</li> <li>• AI-based logistics planning optimisation</li> </ul>
		Supply Chain Control Tower <ul style="list-style-type: none"> <li>• Control tower use case development</li> <li>• Solution test bedding</li> </ul>
		AI-enabled planning and modelling <ul style="list-style-type: none"> <li>• Urban logistics simulator</li> </ul>
		Data Driven Optimisation <ul style="list-style-type: none"> <li>• Dynamic network configuration and simulation</li> <li>• Flexible order management and re-planning</li> <li>• Predictive analytics in supply and demand planning</li> </ul>
Robotics & Automation	<ul style="list-style-type: none"> <li>• Automated Guided Vehicles</li> <li>• Auto Vanning/Devanning</li> <li>• Goods to Man Machines</li> <li>• Robotic Arms for Picking</li> <li>• Smart Warehouse</li> </ul>	Next Generation Distribution Centres & Warehouses <ul style="list-style-type: none"> <li>• Auto vanning and devanning</li> <li>• Warehouse control platform</li> <li>• Robotics for cold chain warehousing</li> </ul>
		Flexible Fulfilment Solutions <ul style="list-style-type: none"> <li>• Learning from demonstration for automated microfulfilment onboarding</li> <li>• Optimal secondary packaging configuration and automation</li> <li>• Integrated packaging customisation</li> <li>• Planning and scheduling</li> </ul>
		Autonomous Mobile Robots <ul style="list-style-type: none"> <li>• Goods-to-Persons AMRs</li> <li>• Unit Transport AMRs</li> </ul>
		Enabling Technologies for Lights-Out Warehousing <ul style="list-style-type: none"> <li>• Lidar Sensing Robotics</li> </ul>
IoT Connectivity	<ul style="list-style-type: none"> <li>• Low Cost IoT</li> <li>• Remote Condition Monitoring</li> <li>• Track and Trace</li> </ul>	IIoT solutions for harsh environments
		IIoT-enabled end-to-end supply chain visibility
		Low-cost, low-power, low-maintenance active IIoTs <ul style="list-style-type: none"> <li>• Energy harvesting IIoT tracker</li> </ul>
Modelling and Simulation	<ul style="list-style-type: none"> <li>• Digital Twins for: <ul style="list-style-type: none"> <li>• Warehouse</li> <li>• Manpower</li> <li>• Route Optimisation</li> <li>• Supply Chain Risk Management</li> </ul> </li> </ul>	Supply and Demand Forecasting <ul style="list-style-type: none"> <li>• Demand-driven inventory planning across channels</li> </ul>
		Intelligent vehicle routing and scheduling <ul style="list-style-type: none"> <li>• Job consolidation and matching functions</li> <li>• Dynamic pricing functions for job matching</li> </ul>
		Digital twinning for warehouse operations
Packaging Solutions	<ul style="list-style-type: none"> <li>• Sustainable Packaging</li> <li>• Green Pallet</li> <li>• Cold Chain Packaging</li> </ul>	Sustainable Packaging Materials <ul style="list-style-type: none"> <li>• Plastic and paper materials with improved recyclability and/or increased recyclable content</li> <li>• Degradable bioplastics packaging</li> </ul>
		Cold Chain Solutions <ul style="list-style-type: none"> <li>• Temperature sensitive labels</li> <li>• Traceable cold chain packaging</li> <li>• Novel materials for ice packs</li> </ul>
		Next generation reusable or upcyclable packaging design

<p>Platform Solutions</p>	<ul style="list-style-type: none"> <li>• Interoperable Platform to enable:             <ul style="list-style-type: none"> <li>• Cross-border Digital Connectivity &amp; Data Sharing</li> </ul> </li> <li>Enabled by Trust Technologies and Sharing Economy</li> </ul>	<p>Trusted Data Platform</p> <ul style="list-style-type: none"> <li>• Federated microservice-based supply chain collaborative platform</li> <li>• Authentication and onboarding framework for massive IoT devices</li> <li>• Secure privacy-preserving data exchange</li> </ul>
		<p>Collaborative last-mile logistics</p> <ul style="list-style-type: none"> <li>• Platforms for logistics ecosystem for pooling and dynamic assignment of trucks</li> <li>• Collaborative fulfilment for quick commerce and return management</li> </ul>
		<p>Warehouse-as-a-Service</p> <ul style="list-style-type: none"> <li>• Inventory management for multi-client warehousing</li> <li>• Cloud-based warehouse management system</li> </ul>
		<p>Collaborative first mile logistics</p> <ul style="list-style-type: none"> <li>• Automated container inspection</li> <li>• Automated container end-to-end return to service</li> </ul>

## Electronics

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Heterogenous integration	<ul style="list-style-type: none"> <li>• GaN</li> <li>• GaAs</li> <li>• SiGe</li> <li>• CMOS</li> <li>• Photonics</li> </ul>	Next generation simulation of materials and manufacturing processes <ul style="list-style-type: none"> <li>• Package Design Technology Co-optimization (P DTCO) to meet power, performance, area and cost requirements</li> </ul>
		Innovative solutions for cross-layer interconnects <ul style="list-style-type: none"> <li>• Advanced Through Die/Stack</li> <li>• Wafer Via/Nano TSV Technologies for packaging scaling of high performance products such as Field Programmable Gate Array (FPGA)</li> </ul>
		Bonding techniques to bring wafers and chips together <ul style="list-style-type: none"> <li>• Advanced Bonding for 2.5D and 3DIC for very high density routing and interconnects</li> </ul>
		Optimized chiplet placement for power, performance and area assisted by AI <ul style="list-style-type: none"> <li>• Heterogeneous Multi Chiplet System in Package</li> </ul>
Wide bandgap	<ul style="list-style-type: none"> <li>• SiC</li> <li>• GaN for clean energy, energy storage systems</li> <li>• E-mobility, defense &amp; space</li> <li>• Telecom infrastructure</li> </ul>	<ul style="list-style-type: none"> <li>• SiC as substrates to ongoing GaN-on-SiC HEMT efforts</li> </ul>
		<ul style="list-style-type: none"> <li>• GaN-on-SiC and GaN-on-Si RF HEMT for mmWave and beyond applications</li> <li>• Gallium oxide as longer-term material for advanced power devices on 6"</li> <li>• GaN-based HEMT fabrication and packaging</li> </ul>
Sensors and actuators	PVD-based PZT <ul style="list-style-type: none"> <li>• Piezoelectric ultrasonic transducers, speakers, micro-mirrors</li> <li>• PZT piezoelectric actuation</li> </ul>	
	AlN with higher concentrations of scandium <ul style="list-style-type: none"> <li>• Photonic IC</li> <li>• Multispectral LiDAR sensor</li> <li>• RF resonators</li> <li>• Piezoelectric micromachined ultrasonic transducers (PMUT)</li> <li>• ScAlN multi-physics</li> </ul>	
	Ge infrared sensors <ul style="list-style-type: none"> <li>• Waveguides, ring resonators, gratings</li> <li>• Metasurfaces, photonic crystals</li> <li>• MEMS emitters and detectors</li> <li>• Ge infrared chemical sensing</li> </ul>	
mmWave and beyond	<ul style="list-style-type: none"> <li>• Reference design flow for SatCom</li> <li>• RF &amp; mmWave ICs/modules, GaN-on-Si power amplifiers</li> <li>• SiGe beamformer IC</li> <li>• 77Ghz radar RFCMOS</li> </ul>	
	<ul style="list-style-type: none"> <li>• Heterogeneously integrated front end modules for RF &amp; mmWave</li> <li>• Fan Out Wafer Level Packaging (FOWLP) &amp; Si interposer platforms</li> <li>• RF/ mmWave package level characterization</li> </ul>	
	<ul style="list-style-type: none"> <li>• THz design blocks LNA, PA, LO, mixer</li> <li>• RF MEMS Sub-mm<sup>2</sup> ScAlN based MEMS filters, phase shifters &amp; timing devices</li> <li>• MEMS based metasurface for mW level THz beam steering</li> <li>• Photonic components</li> </ul>	
Edge AI	<ul style="list-style-type: none"> <li>• Ultra low power Microcontrollers (MCUs) and compute modules</li> <li>• Sensor fusion, Sensing (100uW) and detection (1uW)</li> <li>• Hardware-software optimization</li> </ul>	
	<ul style="list-style-type: none"> <li>• Machine Learning (ML) resistant, non-volatile memory (NVM) based, non-CMOS root of trust</li> </ul>	

	<ul style="list-style-type: none"> <li>• Cross device deep learning side channel attack (&gt;95% accuracy)</li> <li>• Hardware security</li> </ul>
	<ul style="list-style-type: none"> <li>• Scalable neural network (NN) accelerators and compute in memory array</li> <li>• Cryogenic capabilities for quantum</li> </ul>

## Aviation

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Next Generation Air Navigation Services	<ul style="list-style-type: none"> <li>• Performance improvement &amp; workload reduction</li> <li>• Enable seamless operations within Singapore FIR &amp; beyond</li> <li>• Strengthen resilience in ANS systems</li> </ul>	<ul style="list-style-type: none"> <li>• Decision support &amp; analytical tools to optimise airspace management, air traffic flows and aircraft movements on ground</li> </ul>
		<ul style="list-style-type: none"> <li>• New airspace design architecture and concept of operations to maximise airspace capacity, enhance efficiency and reduce workload of air traffic controllers</li> </ul>
		<ul style="list-style-type: none"> <li>• Open ATM architecture platform and associated tools (including ATM twin)</li> </ul>
		<ul style="list-style-type: none"> <li>• System for comprehensive coverage of comms within Singapore's Flight Information Region (FIR)</li> </ul>
Automated & Smart Airport	<ul style="list-style-type: none"> <li>• Digital Airport</li> <li>• Robotics &amp; Automation</li> <li>• Autonomous Assets</li> </ul>	<ul style="list-style-type: none"> <li>• Sensorisation of airport assets and enabling smart &amp; efficient operations through optimisation engines</li> </ul>
		<ul style="list-style-type: none"> <li>• Mobile &amp; dexterous robotics systems to automate manpower-intensive operations</li> </ul>
		<ul style="list-style-type: none"> <li>• Automate towing of baggage &amp; cargo</li> </ul>
		<ul style="list-style-type: none"> <li>• Fleet management systems for improved productivity and dynamic response to disruptions</li> </ul>
Unmanned Systems and Advanced Air Mobility	<ul style="list-style-type: none"> <li>• Autonomous Control Technologies</li> <li>• Advanced / Hybrid Propulsion Technologies</li> <li>• Digitalised Remote Monitoring / Communications</li> </ul>	<ul style="list-style-type: none"> <li>• AI-enabled communication &amp; control and flight dynamics planning for autonomous navigation</li> </ul>
		<ul style="list-style-type: none"> <li>• Intelligent battery management system &amp; cooling solutions</li> </ul>
		<ul style="list-style-type: none"> <li>• Electrification and propulsion technologies</li> </ul>
		<ul style="list-style-type: none"> <li>• Optimisation of flight performance and noise reduction</li> </ul>
Sustainable Air Transport	<ul style="list-style-type: none"> <li>• Sustainable Aviation Fuel (SAF)</li> <li>• Hydrogen Technologies</li> </ul>	<ul style="list-style-type: none"> <li>• Validation of SAF production pathways, feedstock and life cycle assessment to align with global standards</li> </ul>
		<ul style="list-style-type: none"> <li>• Hydrogen fuel cell powered airside ground vehicles</li> </ul>

## Sea Transport

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Next generation port	<ul style="list-style-type: none"> <li>• Full automation of cargo terminals</li> <li>• Smart port maintenance &amp; inspection of port equipment</li> <li>• Next generation vessel traffic management</li> <li>• Port call optimization</li> </ul>	<ul style="list-style-type: none"> <li>• Maritime simulation platform</li> </ul>
		<ul style="list-style-type: none"> <li>• AGV deadlock detection</li> </ul>
		<ul style="list-style-type: none"> <li>• Wharf-side coning/ deconing of twist-locks</li> </ul>
		<ul style="list-style-type: none"> <li>• Next generation vessel traffic management system</li> </ul>
		<i>Additive manufacturing for marine parts (refer to Precision Engineering/Additive Manufacturing for details)</i>
Smart shipping	<ul style="list-style-type: none"> <li>• Smart fleet (ship-shore) operations</li> <li>• Smart harbour craft operations</li> <li>• Autonomous shipping</li> </ul>	<ul style="list-style-type: none"> <li>• Digital meteocean predictor based on oceanographic models</li> <li>• Vessel performance prediction</li> <li>• Structural health management (digital twin) of vessels</li> </ul>
		<ul style="list-style-type: none"> <li>• Immersive technologies tools to create walkthrough of vessels</li> <li>• Next generation navigational research training simulator that takes into consideration of human factors and skills for MASS</li> </ul>
		<ul style="list-style-type: none"> <li>• Maritime autonomous surface ships (MASS)</li> </ul>
Maritime green technologies	<ul style="list-style-type: none"> <li>• Full electric harbour craft and port infrastructure</li> <li>• Circular economy for terminals</li> <li>• Alternative fuels, eg. biofuels, ammonia, hydrogen</li> <li>• Carbon capture, utilisation and storage</li> </ul>	<ul style="list-style-type: none"> <li>• Simultaneous removal of SOx and NOx</li> <li>• NOx removal from ship exhaust gas for vessels</li> </ul>
		<ul style="list-style-type: none"> <li>• LNG-fueled vessels</li> <li>• LNG bunkering vessels</li> </ul>
		<ul style="list-style-type: none"> <li>• Electrification of terminal equipment</li> </ul>

## Food Manufacturing

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Food Technology and Functional Food Innovation	Productisation in Stratified Nutrition	<p>Asian Children Nutrition (2-7 years old)</p> <ul style="list-style-type: none"> <li>• Functional food development for brain development and mental health support</li> <li>• Natural (organic) ingredients and reformulation into final food products for 'clean label'</li> </ul> <p>Asian Elderly Nutrition (55+ years old)</p> <ul style="list-style-type: none"> <li>• Complete food structures development with enhanced bioavailability of nutrients and improved organoleptic and sensorial properties</li> <li>• Fortified food formulation such as bioactives for healthier aging and elderly medical issues like dysphagia</li> </ul> <p>Asian Food Gut Microbiome</p> <ul style="list-style-type: none"> <li>• Novel functional products formulation such as prebiotics, probiotics, postbiotics and synbiotics</li> <li>• Fermentation techniques and cost effective novel delivery methods development such as encapsulation or coating materials for food formats productisation</li> <li>• Microbiome associated interventions e.g. design of food products, to improve nutritional uptake</li> </ul> <p><i>Proposals deemed more suitable for other existing programmes (e.g. Singapore Food Story, Human Potential) would be directed accordingly for better governance and prevent duplicative funding. In general, biomedical and clinical studies are unlikely to be supported under MTC funding.</i></p>
Sustainability	Food Side Stream Valorisation	<p>Green Extractions</p> <ul style="list-style-type: none"> <li>• Novel green solvents for extraction of bioactive compounds, biopeptides, enzymes, biopolymers</li> <li>• Development of cost-effective, scalable green extraction technologies e.g. novel enzyme-assisted technology, solvent-free technologies, combinations of novel techniques</li> </ul> <p>Biomass Processing Techniques</p> <ul style="list-style-type: none"> <li>• Fermentation technology innovation e.g. microbes for improved biomass conversion of lignin, saccharification and lipid accumulation, strain engineering for solid state fermentation, synthesis of chemicals/bioactives etc.</li> <li>• Nanotechnology development for entrapment and release of biomass waste for improved biomass conversion</li> </ul> <p>Processing Systems Design</p> <ul style="list-style-type: none"> <li>• Biocatalytic membrane systems development for upcycled food products</li> <li>• Pre-processing/separation system design of homogeneous food waste to facilitate downstream value adding activities and commercialisation</li> <li>• Food-grade processes and spoilage preventive systems development at side stream source</li> </ul>
	Sustainable food packaging	<p>Novel biopolymers/nanomaterials</p> <ul style="list-style-type: none"> <li>• Novel circular polymer materials, natural polysaccharides, and their derivatives</li> <li>• Bio-based composites and nanocomposites for enhanced biodegradability or recyclability</li> </ul> <p>Coatings/green additives development for plastics</p> <ul style="list-style-type: none"> <li>• Cellulose-based polymers, polyesters</li> <li>• Water-based coating materials</li> <li>• Biodegradable-based additives</li> <li>• Food-grade fillers</li> </ul>

		<p>Performance improvement of sustainable material</p> <ul style="list-style-type: none"> <li>• Improved physicochemical properties of biopolymer-based films (including development of manufacturing technologies)</li> <li>• Enhancement of mechanical and barrier properties of materials</li> <li>• Controlled degradation of materials</li> <li>• New sustainable wood and non-wood fibres innovation</li> <li>• Novel impulse drying technologies optimisation</li> <li>• Fibre preparation and processing technique development</li> </ul>
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## Biomedical

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Biopharmaceutical Manufacturing	Small molecules, Biologics and New Modalities	<p>Biologics</p> <ul style="list-style-type: none"> <li>• Sensing and modelling, simplification and acceleration of closed loop control of biological systems</li> <li>• Sustainability and resilience of supply chain</li> <li>• Compliance agility, making compliance automatic</li> </ul>
		<p>New Modalities (Cell Therapy)</p> <ul style="list-style-type: none"> <li>• Scalable manufacturing platforms</li> <li>• Characterisation and quality</li> <li>• Predictive modelling &amp; system analytics</li> </ul>

## Energy & Chemicals

Focus Areas/Technology Verticals	Key Capabilities and Applications
Specialty chemicals & Advanced materials	<ul style="list-style-type: none"> <li>• Advanced materials processing and Manufacturing techniques</li> <li>• Materials characterisation techniques</li> </ul>
Enablers	<ul style="list-style-type: none"> <li>• AI/ML</li> <li>• Modelling &amp; simulation</li> <li>• Life cycle assessment</li> <li>• Sustainable/alternative materials discovery</li> </ul>



## Satellites

Focus Areas/Technology Verticals	Sub-Focus Areas	Key Capabilities and Applications
Aviation	<ul style="list-style-type: none"> <li>Resilient &amp; reliable comms between pilots and ATC</li> <li>Enhancement of situational awareness</li> <li>Optimization of ATM capacity, improvements in safety &amp; efficiency</li> </ul>	<ul style="list-style-type: none"> <li>Satellite VHF voice comms for air traffic management</li> </ul>
		<ul style="list-style-type: none"> <li>ADS-B resilience for aviation safety</li> </ul>
		<ul style="list-style-type: none"> <li>Accurate &amp; precise weather forecast</li> </ul>
		<ul style="list-style-type: none"> <li>Spaceport operations</li> </ul>
Maritime	<ul style="list-style-type: none"> <li>Comprehensive maritime situational awareness</li> <li>Enhancing navigational safety &amp; efficiency</li> <li>Digital technologies to enhance port efficiency</li> </ul>	<ul style="list-style-type: none"> <li>Dark ship monitoring and characterisation</li> </ul>
		<ul style="list-style-type: none"> <li>VDES for navigational services</li> <li>GNSS resilience</li> </ul>
		<ul style="list-style-type: none"> <li>IoT and VDES to support JIT arrival of ships</li> </ul>
Sustainability & Environment	<ul style="list-style-type: none"> <li>Pollution &amp; hazards detection</li> <li>Understanding climate change drivers, effects &amp; impact to SG</li> <li>Weather prediction</li> </ul>	<ul style="list-style-type: none"> <li>Peatland indicative observables</li> <li>Peatland fire tracking</li> <li>TICs &amp; VOCs detection</li> <li>Volcanic ash monitoring</li> </ul>
		<ul style="list-style-type: none"> <li>Rain radar</li> </ul>
		<ul style="list-style-type: none"> <li>Radio occultation</li> </ul>
		<ul style="list-style-type: none"> <li>Synthetic Aperture Radar Small Satellite (NeuSAR) for all weather earth observation</li> </ul>
Security & Resilience	<ul style="list-style-type: none"> <li>Enhance situational awareness</li> <li>Building comms redundancy &amp; resiliency</li> <li>Cybersecurity</li> </ul>	<ul style="list-style-type: none"> <li>Space-based critical comms back-up</li> <li>Quantum key distribution</li> </ul>
Disruptive technology for small satellites	<ul style="list-style-type: none"> <li>Satellite bus</li> </ul>	<ul style="list-style-type: none"> <li>Very Low Earth Orbit for superior satellite performance and avoid congestion in LEO</li> </ul>
		<ul style="list-style-type: none"> <li>Advanced power and thermal management for higher payload performance and miniaturization</li> <li>Edge computing to reduce datalink requirements even with high performance payloads</li> </ul>
		<ul style="list-style-type: none"> <li>Advanced manufacturing to reduce overall cost and production time while increasing performance</li> </ul>
	<ul style="list-style-type: none"> <li>Payload</li> </ul>	<ul style="list-style-type: none"> <li>Compact optical payloads to reduce overall deployable telescope size using flat optics</li> <li>RF payloads using monolithic advanced deployable antennas to reduce overall size and complexity</li> <li>Advanced communications with high speed intersatellite datalinks for rapid tasking and download of satellite data</li> </ul>
	<ul style="list-style-type: none"> <li>Ground station (GS)</li> <li>Cybersecurity</li> <li>Satellite services</li> <li>Launch services</li> </ul>	<ul style="list-style-type: none"> <li>Advanced GS antenna that can simultaneously communicate with several satellites to overcome land space constraints</li> <li>Cyber-resilience for space infrastructure</li> <li>Quantum sensing</li> <li>Differentiated bundled satellite services</li> <li>Safe and responsive launch within the constraints of Singapore's congested airspace and maritime environment</li> </ul>